



ATTORNEY DOCKET NO.: R. ADDINALL 1-1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ross Addinall, *et al.*
Serial No.: 09/639,288
Filed: August 15, 2000
Title: IMPROVEMENTS IN OR RELATING TO INTEGRATED CIRCUIT DIES
Grp./A.U.: 2814
Examiner: Phat X. Cao

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Commissioner for Patents
Washington, D.C. 20231

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on 3-1-02 (Date)
Elizabeth Schumacher
(Printed or typed name of person signing the certificate)
Elizabeth Schumacher
(Signature of the person signing the certificate)

Sir:

AMENDMENT UNDER 37 C.F.R. § 1.111

In response to the Examiner's Action mailed December 3, 2001, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please amend the title of the invention as follows:

INTEGRATED CIRCUIT DIE FOR WIRE BONDING AND FLIP-CHIP MOUNTING